

# STX83003

# HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- ST83003 SILICON IN TO-92 PACKAGE
- MEDIUM VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

## **APPLICATIONS:**

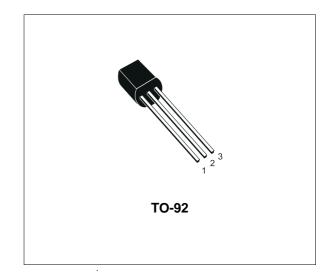
 ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING

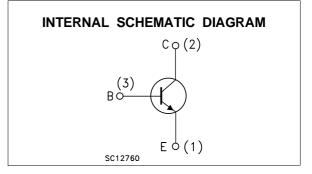
#### DESCRIPTION

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability. It uses a Cellular Emitter structure with planar

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The STX83003 is expressly designed for a new solution to be used in compact fluorescent lamps, where it is coupled with the STX93003, its complementary PNP transistor.





### **ABSOLUTE MAXIMUM RATINGS**

| Symbol           | Parameter  | Value                | Unit |
|------------------|--|----------------------|------|
| VCES             | Collector-Emitter Voltage (V <sub>BE</sub> = 0)  | 700                  | V    |
| V <sub>CEO</sub> | Collector-Emitter Voltage $(I_B = 0)$  | 400                  | V    |
| V <sub>EBO</sub> | Emitter-Base Voltage ( $I_C = 0$ , $I_B = 0.5 A$ , $t_p < 10\mu$ s, $T_j < 150^{\circ}$ C) | V <sub>(BR)EBO</sub> | V    |
| lc               | Collector Current  | 1                    | A    |
| I <sub>CM</sub>  | Collector Peak Current (t <sub>p</sub> < 5 ms)   | 3                    | A    |
| IB               | Base Current   | 0.5                  | А    |
| Івм              | Base Peak Current (t <sub>p</sub> < 5 ms)  | 1.5                  | A    |
| P <sub>tot</sub> | Total Dissipation at $T_{C} = 25 \ ^{\circ}C$  | 1.5                  | W    |
| T <sub>stg</sub> | Storage Temperature  | -65 to 150           | °C   |
| Tj               | Max. Operating Junction Temperature  | 150                  | °C   |

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# THERMAL DATA

| R <sub>thj-case</sub> | Thermal Resistance Junction-Case    | Max | 83.3 | °C/W |   |
|-----------------------|-------------------------------------|-----|------|------|---|
| R <sub>thj-amb</sub>  | Thermal Resistance Junction-Ambient | Мах | 200  | °C/W | 1 |

# **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 °C unless otherwise specified)

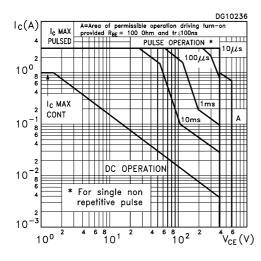
| Symbol   | Parameter   | Test C   | Test Conditions   |               |                   | Max.     | Unit           |
|--|---|--|---|---------------|-------------------|----------|----------------|
| ICES   | Collector Cut-off<br>Current (V <sub>BE</sub> = 0)              | V <sub>CE</sub> = 700V<br>V <sub>CE</sub> = 700V                                     | T <sub>j</sub> = 125 <sup>o</sup> C                                     |               |                   | 1<br>5   | mA<br>mA       |
| V <sub>(BR)EBO</sub>                               | Emitter-Base<br>Breakdown Voltage<br>(I <sub>C</sub> = 0)       | I <sub>E</sub> = 10 mA   |   | 12            |                   | 18       | V              |
| $V_{CEO(sus)^*}$                                   | Collector-Emitter<br>Sustaining Voltage<br>(I <sub>B</sub> = 0) | I <sub>C</sub> = 10 mA<br>L = 25 mH  |   | 400           |                   |          | V              |
| V <sub>CE(sat)</sub> *                             | Collector-Emitter<br>Saturation Voltage                         | I <sub>C</sub> = 0.5 A<br>I <sub>C</sub> = 0.35 A                                    | I <sub>B</sub> = 0.1 A<br>I <sub>B</sub> = 50 mA                        |               |                   | 0.5<br>1 | V<br>V         |
| V <sub>BE(sat)</sub> *                             | Base-Emitter<br>Saturation Voltage                              | I <sub>C</sub> = 0.5 A   | I <sub>B</sub> = 0.1 A  |               |                   | 1        | V              |
| h <sub>FE</sub> *                                  | DC Current Gain   | $I_{C} = 10 \text{ mA}$<br>$I_{C} = 0.35 \text{ A}$<br>$I_{C} = 1 \text{ A}$         | V <sub>CE</sub> = 5 V<br>V <sub>CE</sub> = 5 V<br>V <sub>CE</sub> = 5 V | 10<br>16<br>4 | 25                | 32       |                |
| t <sub>r</sub><br>t <sub>s</sub><br>t <sub>f</sub> | RESISTIVE LOAD<br>Rise Time<br>Storage Time<br>Fall Time        | $I_{C} = 0.35 \text{ A}$<br>$I_{B1} = 70 \text{ mA}$<br>$T_{p} \ge 25  \mu \text{s}$ | $V_{CC} = 125 V$<br>$I_{B2} = -70 mA$<br>(see figure 2)                 | 1.5           | 100<br>2.2<br>0.2 | 2.9      | ns<br>μs<br>μs |
| t <sub>s</sub><br>t <sub>f</sub>                   | INDUCTIVE LOAD<br>Storage Time<br>Fall Time                     | $I_{C} = 0.5 A$ $V_{BE(off)} = -5 V$ $V_{clamp} = 300 V$                             | I <sub>B1</sub> = 0.1 A<br>L = 10 mH<br>(see figure 1)                  |               | 450<br>90         |          | ns<br>ns       |

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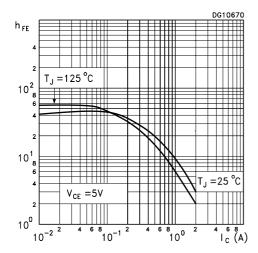
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\* Pulsed: Pulse duration = 300µs, duty cycle = 1.5 %.

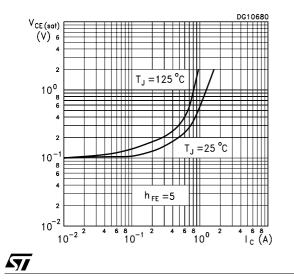
# Safe Operating Area



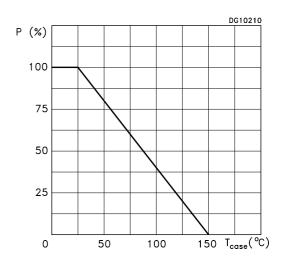
# DC Current Gain



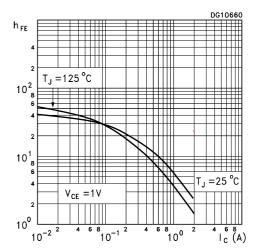
# Collector Emitter Saturation Voltage



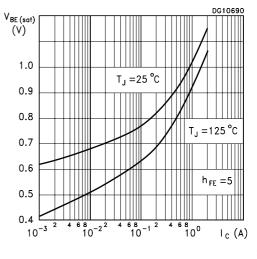
# **Derating Curve**



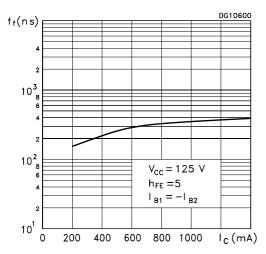
# DC Current Gain



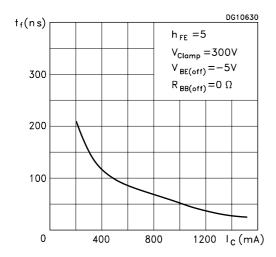




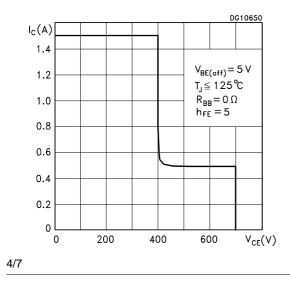
# Resistive Load Fall Time



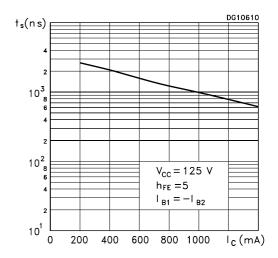
## Inductive Load Fall Time



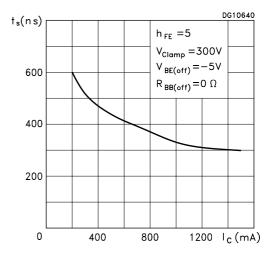
## **Reverse Biased SOA**



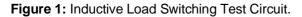
#### **Resistive Load Storage Time**



## Inductive Load Storage Time



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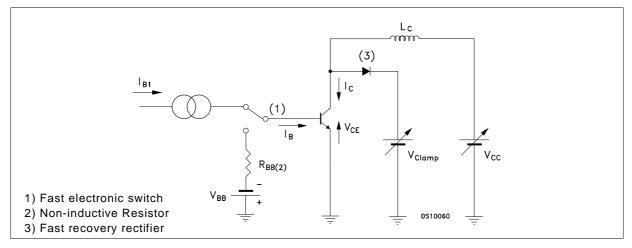
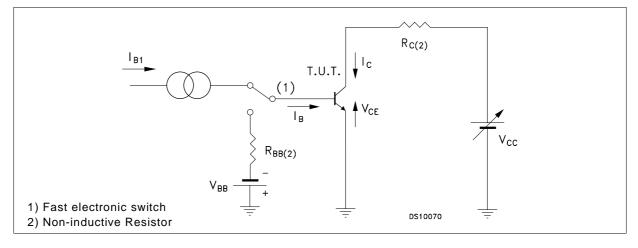
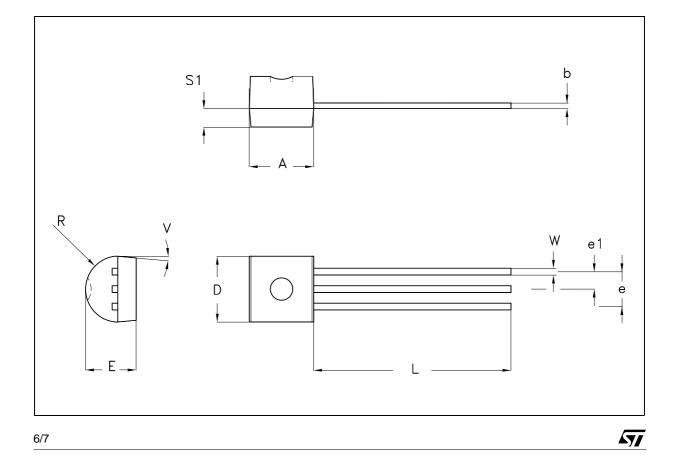


Figure 2: Resistive Load Switching Test Circuit.



| DIM. |          | mm   |          |          | inch |          |
|------|----------|------|----------|----------|------|----------|
|      | MIN.     | TYP. | MAX.     | MIN.     | TYP. | MAX.     |
| А    | 4.32     |      | 4.95     | 0.170    |      | 0.195    |
| b    | 0.36     |      | 0.51     | 0.014    |      | 0.020    |
| D    | 4.45     |      | 4.95     | 0.175    |      | 0.194    |
| Е    | 3.30     |      | 3.94     | 0.130    |      | 0.155    |
| е    | 2.41     |      | 2.67     | 0.095    |      | 0.105    |
| e1   | 1.14     |      | 1.40     | 0.045    |      | 0.055    |
| L    | 12.70    |      | 15.49    | 0.500    |      | 0.609    |
| R    | 2.16     |      | 2.41     | 0.085    |      | 0.094    |
| S1   | 1.14     |      | 1.52     | 0.045    |      | 0.059    |
| W    | 0.41     |      | 0.56     | 0.016    |      | 0.022    |
| V    | 4 degree |      | 6 degree | 4 degree |      | 6 degree |





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